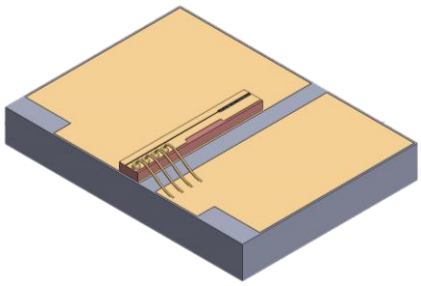
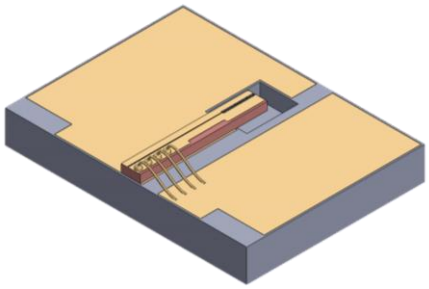
Specification Sheet | **866.214 nm Series**

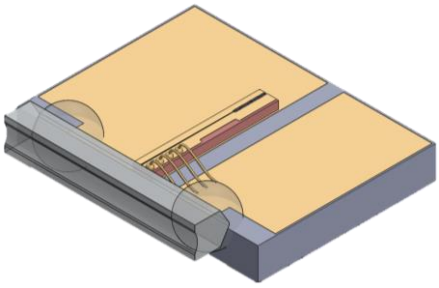
Distributed Bragg Reflector (DBR) Laser Diode



Chip on Submount (CoS)



CoS + Mode-Hop Free (MHF)



CoS + Virtual Point Source (VPS) Lens

Description

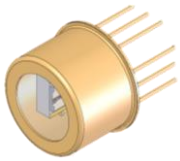
The 866.214 nm DBR Series of high-performance edge-emitting laser diodes are based on Photodigm's advanced monolithic single-frequency Gallium Arsenide (GaAs) based laser technology. It provides a single spatial mode beam and has passivated facets for reliability. The 866.214 nm Series DBR devices are used in atomic spectroscopy for calcium ion-based (Ca^+) applications. The 866.214 nm Series DBR devices are Spectroscopy Certified; guaranteed to hit the Ca^+ cooling transition (Ca^+ CT) ± 10 °C from room temperature.

866.214 nm DBR Chip on Submount (CoS) Characteristics

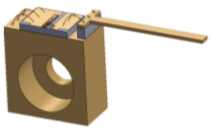
	Chip Architecture
Parameters[1]	**High Power**
Wavelength, Nominal (nm)[2]	866.214 ± 0.6
Power Range (mW)	80–240
Operating Current, Max (CW & Pulsed) (mA)	350
Optical Power at Max Operating Current (mW)	240
Slope Efficiency, Nominal (W/A)	0.9
Threshold Current, Nominal (mA)	50

1. Characteristics at T_C = 25 °C unless otherwise specified. Operating outside of these parameters voids warranty.
2. Hermetically sealed packages may contain CoS that are ± 1.2 nm from nominal

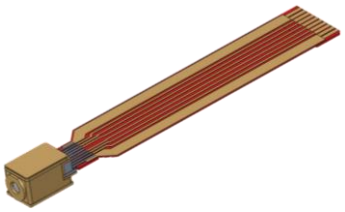
Available Free-Space Package Add-ons



TO-8



C-Mount



Transmitter Optical Subassembly (TOSA)

Photodigm, Inc.
www.photodigm.com
3.13.2024
972-235-7584
1155 E Collins Blvd, #200, Richardson, TX 75081

Specification Sheet | **866.214 nm Series**

Distributed Bragg Reflector (DBR) Laser Diode

Specifications

Laser

Parameter	Unit	Min	Typical	Max
Storage Temperature	°C	0	-	70
Operating Temperature at case	°C	5	-	70
Operating Temperature at laser chip[1]	°C	5	-	45
Laser Series Resistance	Ω	-	2	-
Laser Forward Voltage @ LIV Current	V	-	2	-
Nominal Laser Linewidth @ LIV Current	kHz	-	500	-
Beam Divergence @ FWHM ($\theta_{\parallel}$ x $\theta_{\perp}$)	º	-	6 x 28	8 x 32
Side Mode Suppression Ratio (SMSR)	dB	-	-40	-
Polarization Extinction Ratio	dB	-17	-20	-
Laser Polarization	TE			
Mode Structure	Fundamental Mode			
Temperature Tuning Rate	nm/°C	-	0.06	-
Current Tuning Rate	nm/mA	-	0.002	-
Laser Reverse Voltage	V	-	-	0

1. Operation below dew point not recommended without hermetically sealed packaged

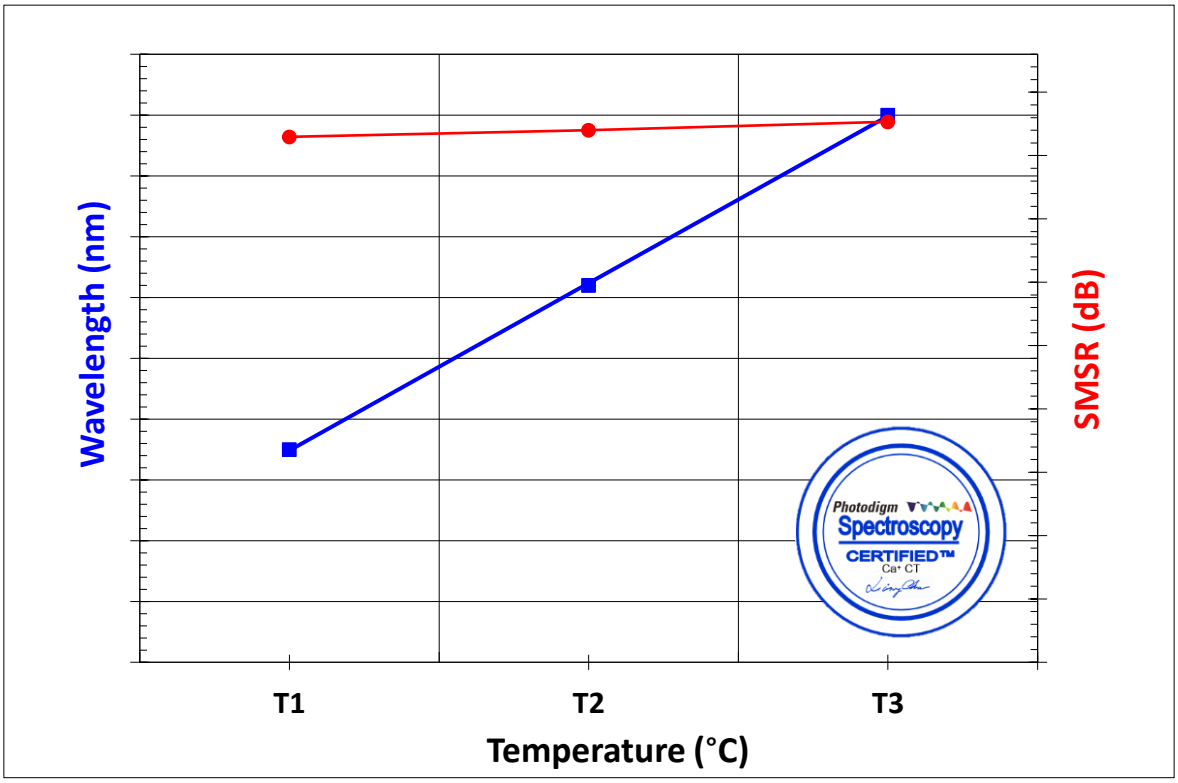
Free-Space Package Add-Ons

Parameter	Unit	Min	Typical	Max
Photodiode Forward Current	mA	-	-	10
Photodiode Reverse Voltage	V	-	-	50
TEC Current (TOSA)	A	-1.1	-	1.1
TEC Voltage (TOSA)	V	-3.0	-	3.0
TEC Current (TO-8)	A	-1.8	-	1.8
TEC Voltage (TO-8)	V	-2.2	-	2.2
Thermistor Resistance	kΩ	-	10	-

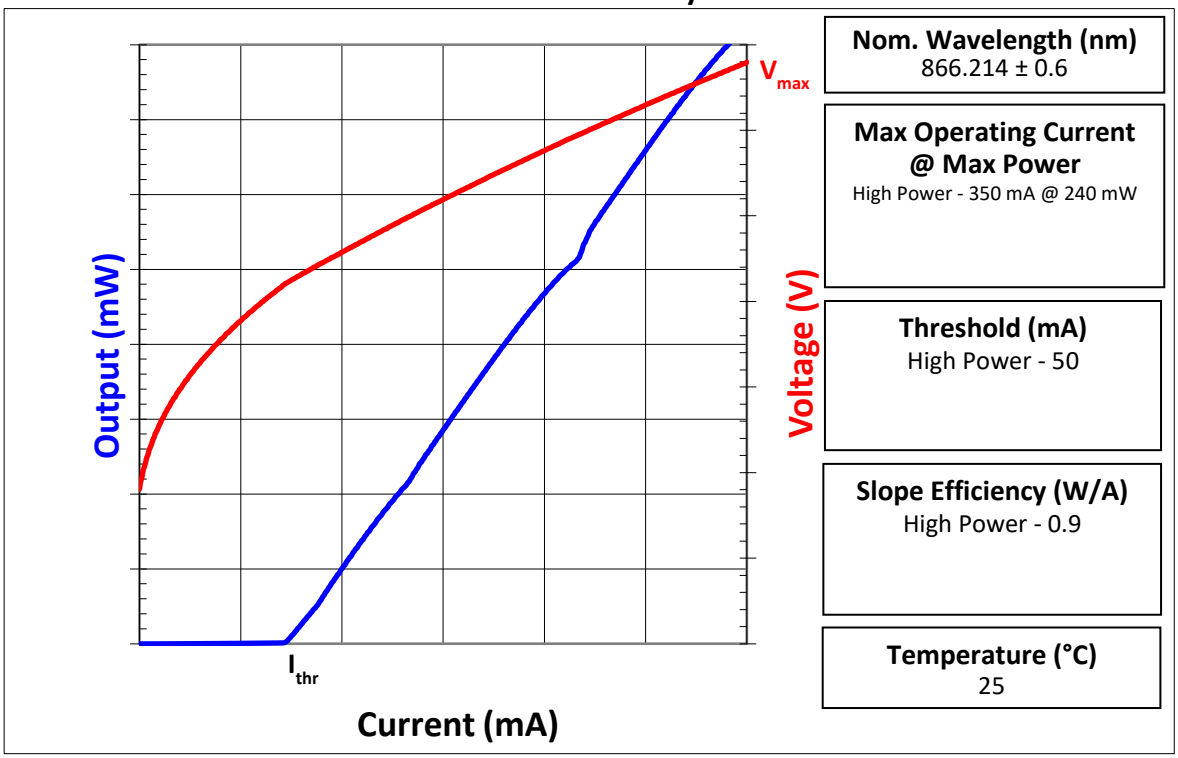
Handling Precautions

These devices are sensitive to ESD. When handling the module, grounded work area and wrist strap must be used. Always store in an antistatic container with all leads shorted together.

Air Wavelength Characteristics at Constant Current by Temperature



LIV Characteristics by Current



Nom. Wavelength (nm)
866.214 ± 0.6

Max Operating Current @ Max Power
High Power - 350 mA @ 240 mW

Threshold (mA)
High Power - 50

Slope Efficiency (W/A)
High Power - 0.9

Temperature (°C)
25